







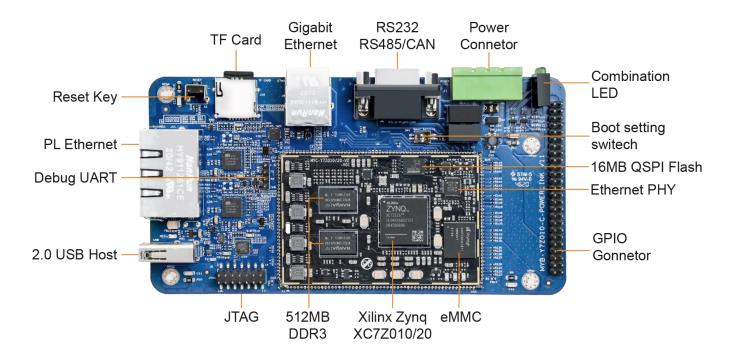
- ✓ MYC-Y7Z010/20-V2 CPU Module as Controller Board
- ✓ 1.27mm pitch 180-pin Stamp Hole Expansion Interface for Board-to-Board Connections
- ✓ 667MHz Xilinx XC7Z010 or XC7Z020 ARM Cortex-A9 Processor with Xilinx 7-series FPGA logic
- ✓ 512MB DDR3 SDRAM (2 x 256MB, 32-bit)
- ✓ 4GB eMMC Flash, 16MB QSPI Flash
- ✓ USB Host, 3 x Gigabit Ethernet ports, RS232, RS485, CAN, TF, JTAG, GPIO...
- ✓ Ready-to-Run Linux 4.14





The <u>MYD-Y7Z010/20-V2</u> <u>development board</u> is powered by **Xilinx XC7Z020** (<u>Zynq-7020</u>) or **XC7Z010** (<u>Zynq-7010</u>) SoC device. It is a cost-effective and high-performance solution for industrial application such as Industrial Ethernet, machine vision, PLC/HMI and etc. The board is ready to run **Linux** and supports industrial operating temperature ranging from -40 to +85 Celsius.

The MYD-Y7Z010/20-V2 development board employs the MYC-Y7Z010/20-V2 as the controller board by populating the CPU Module on its base board through 1.27mm pitch 180-pin stamp-hole (Castellated-Hole) interface, allowing users to take the advantages of numerous extended out signals. Core components on CPU Module including Z-7010 or Z-7020 processor, 512MB DDR3 SDRAM, 4GB eMMC, 16MB QSPI Flash, Gigabit Ethernet PHY and external watchdog. Additionally, the MYD-Y7Z010/20-V2 development board takes full features of the or Z-7020 all programmable SoC to create a rich set of peripherals to the base board through headers and connectors including RS232, RS485, USB Host, three Gigabit Ethernet ports, CAN, TF card slot, JTAG as well as one 2.54mm pitch 2 x 25-pin expansion header to let more GPIOs available for further extension.



MYD-Y7Z010/20-V2 Development Board



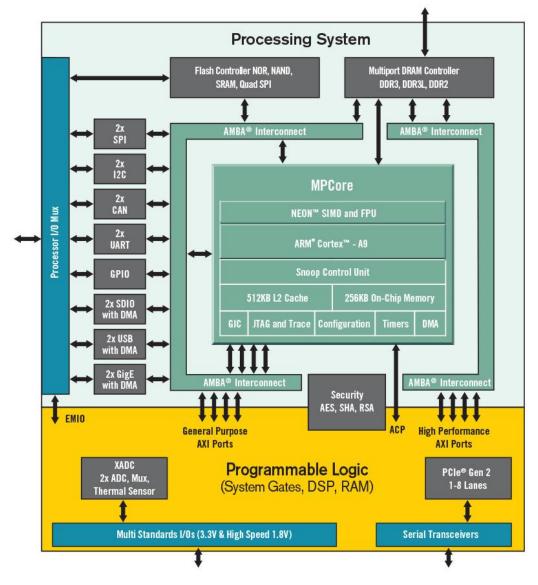


Hardware Specification

The Zynq®-7000 All Programmable SoC (AP SoC) family integrates the software programmability of an ARM®-based processor with the hardware programmability of an FPGA, enabling key analytics and hardware acceleration while integrating CPU, DSP, ASSP, and mixed signal functionality on a single device. Consisting of single-core Zynq-7000S and dual-core Zynq-7000 devices, the Zynq-7000 family is the best price to performance per-watt, fully scalable SoC platform for your unique application requirements.

Zynq-7000S

Zynq-7000S devices feature a single-core ARM Cortex[™]-A9 processor mated with 28nm Artix®-7 based programmable logic, representing the lowest cost entry point to the scalable Zynq-7000 platform. It includes Zynq Z-7007S, Z-7012S and Z-7014S which target smaller embedded designs. Available with 6.25Gb/s transceivers and outfitted with commonly used hardened peripherals, the Zynq-7000S delivers cost-optimized system integration ideal for industrial IoT applications such as motor control and embedded vision.

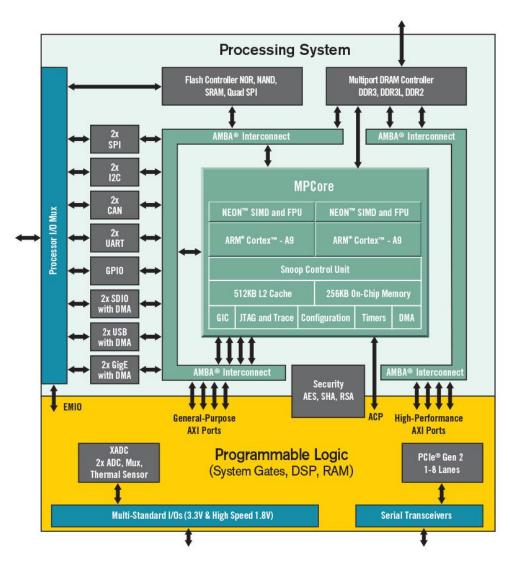


Zyng Z-7000S SoC Device Block Diagram



Zynq-7000

Zynq-7000 devices are equipped with dual-core ARM Cortex-A9 processors integrated with 28nm Artix-7 or Kintex®-7 based programmable logic for excellent performance-per-watt and maximum design flexibility. With up to 6.6M logic cells and offered with transceivers ranging from 6.25Gb/s to 12.5Gb/s, Zynq-7000 devices enable highly differentiated designs for a wide range of embedded applications including multi-camera drivers assistance systems and 4K2K Ultra-HDTV.



Zynq Z-7000 SoC Device Block Diagram





Zynq®-7000 All Programmable SoC Family

	Cost-Optimized Devices			Mid-Range Devices							
Device Nam	2-7007S	Z-7012S	Z-7014S	Z-7010	Z-7015	Z-7020	Z-7030	Z-7035	Z-7045	Z-7100	
Part Numbe	r XC7Z007S	XC7Z012S	XC7Z014S	XC7Z010	XC7Z015	XC7Z020	XC7Z030	XC7Z035	XC7Z045	XC7Z100	
Processor Cor	4.000	Single-Core ARM® Cortex™-A9 MPCore™ Up to 766MHz			Dual-Core ARM Cortex-A9 MPCore Up to 866MHz			Dual-Core ARM Cortex-A9 MPCore Up to 1GHz ^[1]			
Processor Extension	s	NEON™ SIMD Engine and Single/Double Precision Floating Point Unit per processor									
L1 Cach	32KB Instruction, 32KB Data per processor										
L2 Cach	2	512KB									
On-Chip Memor	y	256KB									
External Memory Support	9	DDR3, DDR2L, DDR2, LPDDR2									
External Static Memory Support	1)	2x Quad-SPI, NAND, NOR									
DMA Channel	s	8 (4 dedicated to PL)									
Peripheral	5	2x UART, 2x CAN 2.0B, 2x I2C, 2x SPI, 4x 32b GPIO									
Peripherals w/ built-in DMA	1	2x USB 2.0 (OTG), 2x Tri-mode Gigabit Ethernet, 2x SD/SDIO									
Security ⁽	RSA Authentication of First Stage Boot Loader, AES and SHA 256b Decryption and Authentication for Secure Boot										
Processing System to Programmable Logic Interface Port (Primary Interfaces & Interrupts Only	2x AXI 32b Master, 2x AXI 32b Slave 4x AXI 64b/32b Memory AXI 64b ACP 16 Interrupts										
7 Series PL Equivalen	t Artix®-7	Artix-7	Artix-7	Artix-7	Artix-7	Artix-7	Kintex®-7	Kintex-7	Kintex-7	Kintex-7	
Logic Cell	23K	55K	65K	28K	74K	85K	125K	275K	350K	444K	
Look-Up Tables (LUTs	14,400	34,400	40,600	17,600	46,200	53,200	78,600	171,900	218,600	277,400	
Flip-Flop	28,800	68,800	81,200	35,200	92,400	106,400	157,200	343,800	437,200	554,800	
Total Block RAM	1.8Mb	2.5Mb	3.8Mb	2.1Mb	3.3Mb	4.9Mb	9.3Mb	17.6Mb	19.2Mb	26.5Mb	
(# 36Kb Blocks	(50)	(72)	(107)	(60)	(95)	(140)	(265)	(500)	(545)	(755)	
DSP Slice	66	120	170	80	160	220	400	900	900	2,020	
PCI Express	_	Gen2 x4		577.5	Gen2 x4	900	Gen2 x4	Gen2 x8	Gen2 x8	Gen2 x8	
Analog Mixed Signal (AMS) / XADC	9	2x 12 bit, MSPS ADCs with up to 17 Differential Inputs									
Security ⁽	1	AES & SHA 256b Decryption & Authentication for Secure Programmable Logic Config									
Commercia		-1	N-B-CON B		-1			-1	Maria Company	-1	
Speed Grades Extende	t l	-2			-2,-3			-2,-3			
Industria	-1, -2			-1, -2, -1L			-1, -2, -2L		-1, -2, -2L		

Zynq-7000 SoC Device Table

Mechanical Parameters

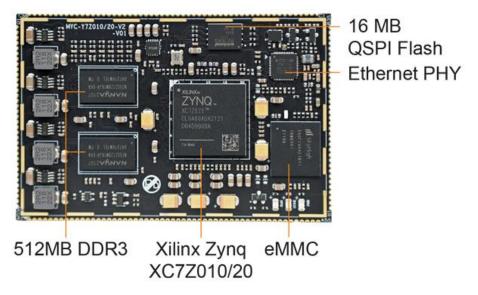
Dimensions: 153mm x 80mm (base board), 75mm x 50mm (CPU Module)

PCB Layers: 4-layer design (base board), 10-layer design (CPU Module)

Power supply: 12V/2A

Working temp.: -40~85 Celsius

The MYD-Y7Z010/20-V2 Controller Board (MYC-Y7Z010/20-V2 CPU Module)



MYC-Y7Z010/20-V2 CPU Module

^{1.1} GHz processor frequency is available only for -3 speed grades in Z-7030, Z-7035, and Z-7045 devices. See <u>DS 190</u>, Zynq-7000 All Programmable Soc Overview for details.
2. Z-7007S and Z-7710 in CLG225 have restrictions on PS peripherals, memory interfaces, and I/Os. Please refer to <u>UGS85</u>, Zynq-7000 All Programmable Soc Technical Reference Manual for more details.
3. Security block is shared by the Processing System and the Programmable Logic.



SoC

- Xilinx XC7Z010-1CLG400C (Zynq-7010) or XC7Z020-1CLG400C (Zynq-7020)
 - 667MHz ARM® dual-core Cortex[™]-A9 MPCore processor (up to 866MHz)
 - Integrated Artix-7 class FPGA subsystem with 28K logic cells, 17,600 LUTs, 80 DSP slices (for XC7Z010) with 85K logic cells, 53,200 LUTs, 220 DSP slices (for XC7Z020)
 - NEON™ & Single / Double Precision Floating Point for each processor
 - Supports a Variety of Static and Dynamic Memory Interfaces

Memory

- 512MB DDR3 SDRAM
- 4GB eMMC Flash
- 16MB QSPI Flash

Peripherals and Signals Routed to Pins

- Gigabit Ethernet PHY (YT8521SH)
- External watchdog
- Three LEDs
 - One red LED for power indicator
 - One green LED for FPGA program done indicator
 - One flashing green LED for system indicator
- 1.27mm 180-pin expansion connectors bring out below signals:
 - One Gigabit Ethernet
 - One USB OTG2.0
 - Two Serial ports
 - Two I2C
 - Two CAN BUS
 - Two SPI
 - * Serial ports, I2C, CAN and SPI signals can be implemented through PL pins
 - ADC (one independent differential ADC, 16-channel ADC brought out through PL pins)
 - One SDIO

The MYD-Y7Z010/20-V2 Base Board (MYB-Y7Z010/20)

PS Unit

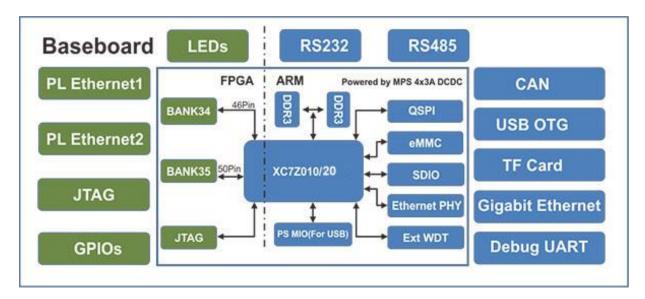
- One USB Host
- One RS232 serial port (with isolation)
- One RS485 (with isolation)
- One TF card slot
- One CAN interface (with isolation)
- One 10/100/1000Mbps Ethernet interface
- One 2.54mm pitch 14-pin JTAG interface
- One Debug serial port (UART)

PL Unit

- One 2.54mm pitch 2 x 25-pin GPIO expansion headers
- Two 10/100/1000Mbps Ethernet interfaces
- Three user LEDs

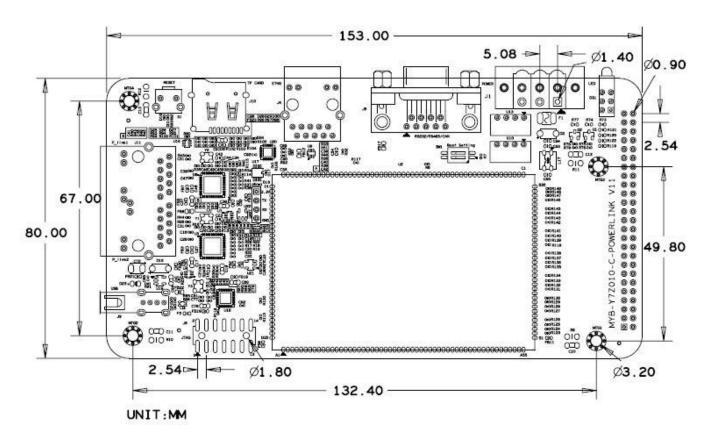


Function Block Diagram



Function Block Diagram of MYD-Y7Z010/20-V2

Dimension Chart



Dimension Chart of MYD-Y7Z010/20-V2





Software Features

Item	Features	Description	Remark	
Cross compiler	gcc 6.2.1	gcc version 6.2.1 20161114 (Linaro GCC Snapshot 6.2-2016.11)		
Boot program	BOOT.BIN	First boot program including FSBL, bitstream	Source code provided	
	u-boot	Secondary boot program	Source code provided	
Linux Kernel	Linux 4.14	Customized kernel for MYD-Y7Z010/20-V2 Development Board	Source code provided	
	USB Host	USB Host driver	Source code provided	
	Ethernet	Gigabit Ethernet driver	Source code provided	
Duissaus	MMC/SD/TF	MMC/SD/TF card driver	Source code provided	
	CAN	CAN driver	Source code provided	
	LCD Controller	LCD driver	Source code provided	
	HDMI	HDMI (SII902X chip) driver	Source code provided	
	Button	Button driver	Source code provided	
	UART	UART driver	Source code provided	
	LED	LED driver	Source code provided	
	GPIO	GPIO driver	Source code provided	
	QSPI	QSPI Flash W25Q128FW driver	Source code provided	
	RTC	DS3231 RTC driver	Source code provided	
	Resistive Touch	TSC2007 resistive touch screen driver	Source code provided	
	Capacitive Touch	FT5X0X capacitive touch screen driver	Source code provided	
	ADC	ADC driver	Source code provided	
File System	Ramdisk	Ramdisk system image		
File System	Rootfs.tar	Tar file		